

# MX1536G LDMOS TRANSISTOR

Document Number: MX1536G  
Product Datasheet V1.0

## 110W, 12.5V High Power RF LDMOS FETs

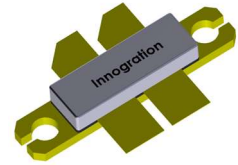
### Description

The MX1536G is a 110-watt capable, highly rugged, unmatched, push pull LDMOS FET, designed for wide-band commercial and industrial applications with frequencies HF to 600MHz.

• Typical Performance (On Innogration fixture with device soldered):

Vgs=2.44V Vds=12.5V Idq=140mA CW								
Freq (MHz)	Psat (dBm)	Psat (W)	Ids (A)	Pin (dBm)	Gain (dB)	Eff (%)	2nd (dBc)	3rd (dBc)
136	50.51	112.46	13.09	31.5	19.01	68.73	-22.4	-11.4
145	50.86	121.90	14.07	31.58	19.28	69.31	-24.5	-10.6
155	51.24	133.05	14.83	31.9	19.34	71.77	-27.0	-10.0
165	51.31	135.21	14.66	32.35	18.96	73.78	-28.0	-12.7
174	50.55	113.50	12.01	32.7	17.85	75.60	-30.0	-13.1

MX1536G



### Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

### Suitable Applications

- 2-30MHz (HF or Short wave communication)
- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 118 -140MHz (Avionics)
- 136-174MHz (Commercial ground communication)
- 160-230MHz (TV VHF III)
- 30-512MHz (Jammer, Ground/Air communication)

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain--Source Voltage	V <sub>DSS</sub>	+65	Vdc
Gate--Source Voltage	V <sub>GS</sub>	-10 to +10	Vdc
Operating Voltage	V <sub>DD</sub>	+28	Vdc
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Case Operating Temperature	T <sub>c</sub>	+150	°C
Operating Junction Temperature	T <sub>j</sub>	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case T <sub>c</sub> = 85°C, P <sub>out</sub> =110W,CW Test	R <sub>θJC</sub>	0.24	°C/W

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**Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22--A114)	Class 2

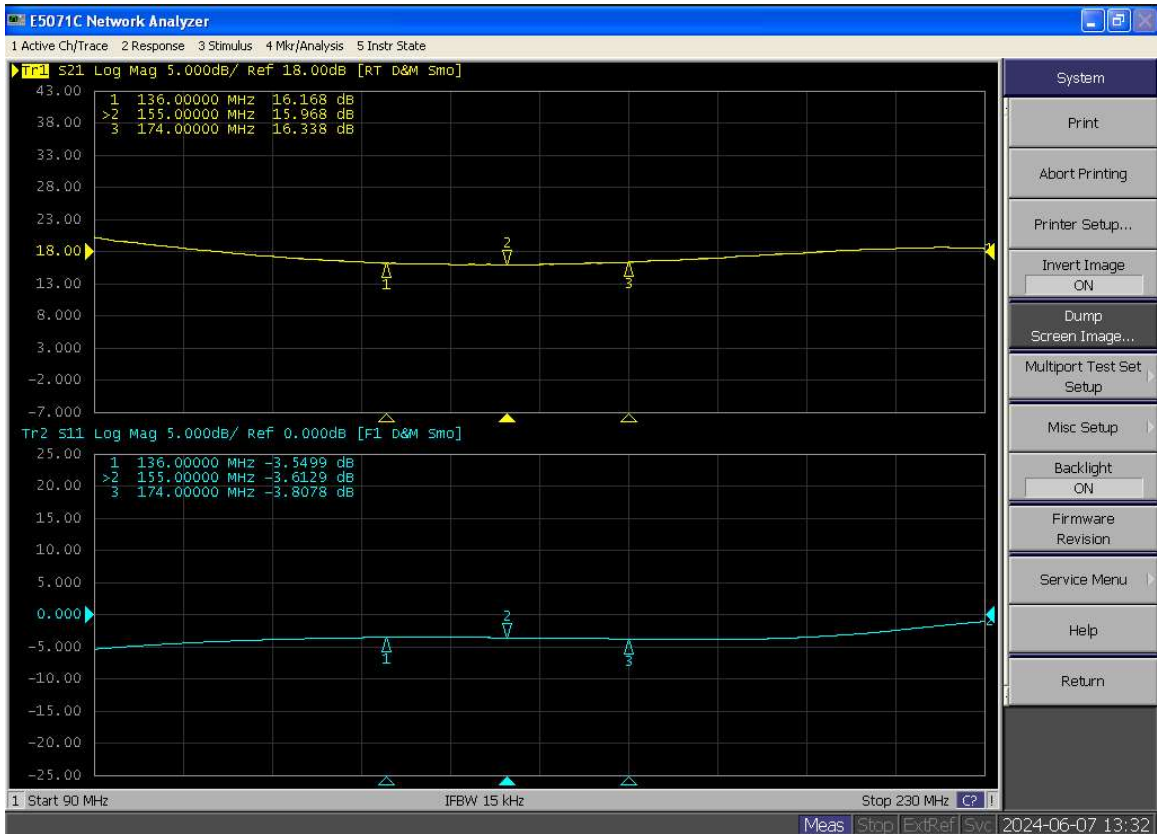
**Table 4. Electrical Characteristics** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>DC Characteristics (per half section)</b>					
Drain-Source Voltage $V_{GS}=0$ , $I_{DS}=1.0\text{mA}$	$V_{(BR)DSS}$	65			V
Zero Gate Voltage Drain Leakage Current ( $V_{DS} = 75\text{V}$ , $V_{GS} = 0\text{V}$ )	$I_{DSS}$	—	—	1	$\mu\text{A}$
Zero Gate Voltage Drain Leakage Current ( $V_{DS} = 28\text{V}$ , $V_{GS} = 0\text{V}$ )	$I_{DSS}$	—	—	1	$\mu\text{A}$
Gate--Source Leakage Current ( $V_{GS} = 10\text{V}$ , $V_{DS} = 0\text{V}$ )	$I_{GSS}$	—	—	1	$\mu\text{A}$
Gate Threshold Voltage ( $V_{DS} = 12.5\text{V}$ , $I_D = 400\text{ }\mu\text{A}$ )	$V_{GS(th)}$	—	2	—	V
Gate Quiescent Voltage ( $V_{DD} = 12.5\text{V}$ , $I_D = 250\text{mA}$ , Measured in Functional Test)	$V_{GS(Q)}$	—	2.5	—	V

**Load Mismatch (In Innogration Test Fixture, 50 ohm system):**  $V_{DD} = 12.5\text{Vdc}$ ,  $I_{DQ} = 200\text{mA}$ ,  $f = 174\text{MHz}$

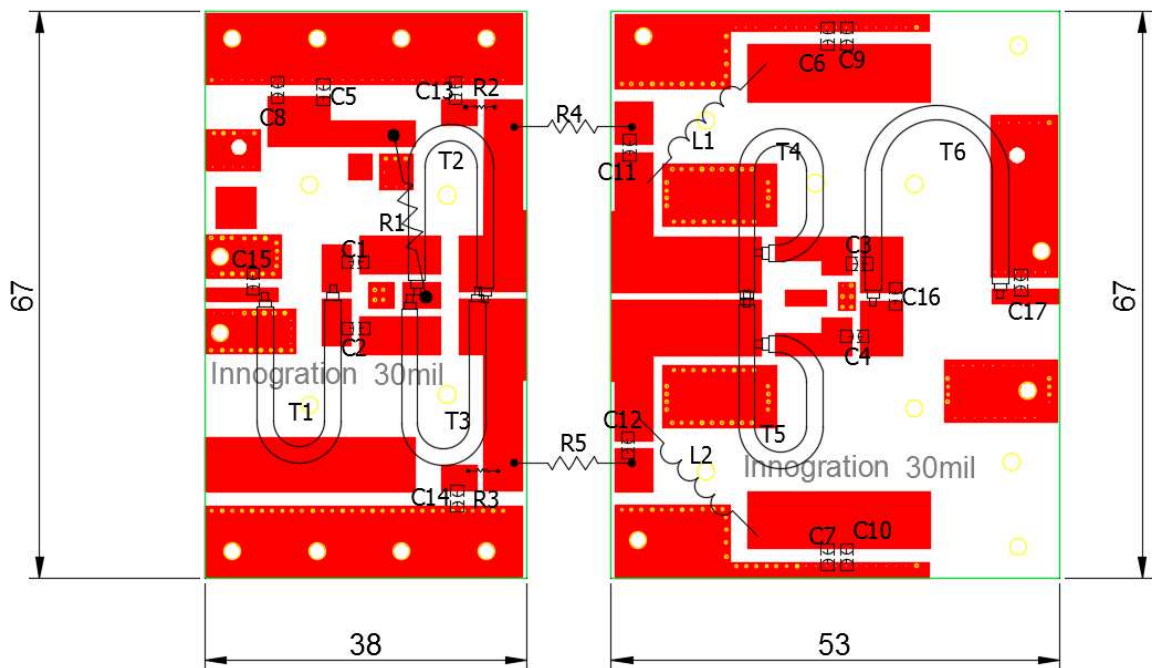
Load open and short, at 110W CW	No Device Degradation
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**Figure 1: Network analyzer Output S11/S21**



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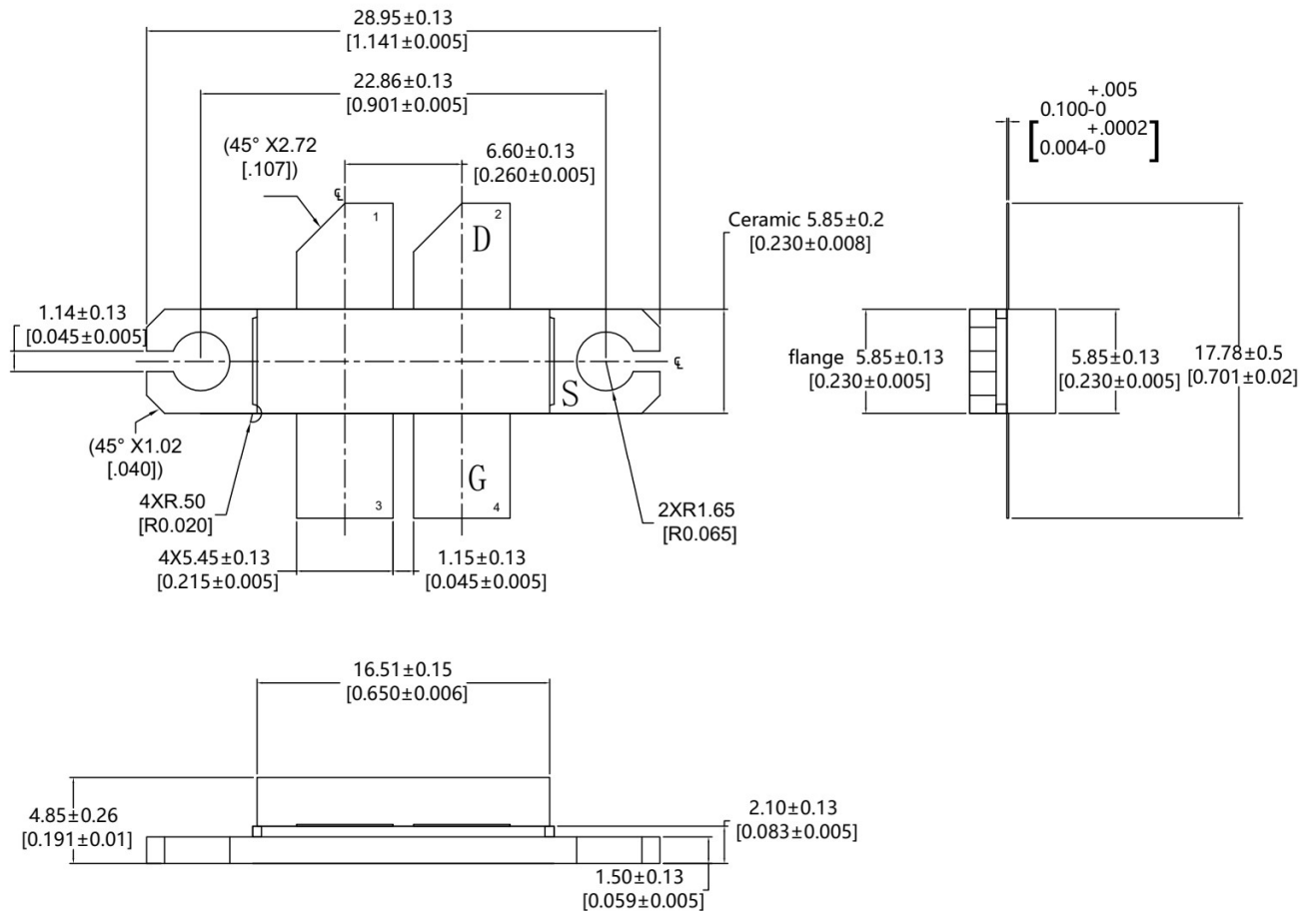
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Component	Description	Suggestion
C1~C4	470pF	BEIJING YUANLU HONGYUAN ELECTRONIC TECHNOLOGY CO., LTD.MQ101111
C5~C7	560pF	BEIJING YUANLU HONGYUAN ELECTRONIC TECHNOLOGY CO., LTD.MQ101111
C8~C14	10uF/100V	Ceramic Multilayer Capacitor
C15	15pF	BEIJING YUANLU HONGYUAN ELECTRONIC TECHNOLOGY CO., LTD.MQ101111
C16,C17	10pF	BEIJING YUANLU HONGYUAN ELECTRONIC TECHNOLOGY CO., LTD.MQ301111
R1	330 $\Omega$	plug-in resistor
R2,R3	18 $\Omega$ 1206	Chip Resistor
R4,R5	470 $\Omega$	plug-in resistor
T1	50ohm 100mm	RFSFBU-086-50
T2,T3	16.7ohm 100mm	SFF-16.7-1.5
T4,T5	12.5ohm 100mm	SFF-25-1.5
T6	25ohm 100mm	RFSFBU-086-25
L1,L2	1.5mm enamelled wire, inner diameter 3mm, 6 turns	DIY
PCB	30Mil Rogers4350	

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**Flanged ceramic package; 2 mounting holes; 4 leads**



OUTLINE VERSION	REFERENCE			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
PKG-LB/LBB					05/21/2021

## Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2024/6/7	Rev 1.0	Product Datasheet Creation

Application data based on HL-24-12

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